Filter specification **TFS 869L** 1/5 Microchip

cMeasurement condition

°C Ambient temperature: 23 Input power level: 0 dBm

Terminating impedance: *

50 Ω Input: Output: 50 Ω

Source: 464 Ω || -1.1 pF 379 Ω || -1.2 pF Load:

Characteristics

Remark:

The reference level for the relative attenuation a_{rel} of the TFS869L is the maximum of the passband attenuation a_{max} . The maximum of the passband attenuation a_{max} is defined as the insertion loss a_e . The nominal frequency f_N is fixed at 869.2125 MHz without any tolerance. The values of the relative attenuation a_{rel} are guaranteed over the whole operating temperature range. The frequency shift of the filter within the operating temperature range is included in the production tolerance scheme.

Data		typ. v	value	tole	rance / li	mit
Insertion loss	a _e	2.0	dB	max.	3.0	dB
(reference level)						
Nominal frequency	f _N	-			869.2125	MHz
Passband	РВ	-		f _N ±	12.5	kHz
Passband variation		0.1	dB	max.	1.0	dB
Relative attenuation	a _{rel}					
1 MHz f _N - 2	MHz	18	dB	min.	15	dB
f _N + 2 MHz 900	MHz	20	dB	min.	15	dB
Input power level		-		max.	10**	dBm
Operating temperature range	range OTR 10 °C + 55°C					
Storage temperature range		-		- 40 °C + 85°C		
Frequency inversion temperature		23	°C			
Temperature coefficient of frequency	TC _f ***	-0.03	ppm/K²			

^{*)} The terminating impedances depend on parasitics and q-values of matching elements and the board used, and are to be understood as reference values

Generated:

Checked / Approved:		

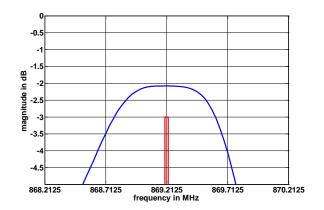
Microchip Frequency Technology GmbH Potsdamer Straße 18 D 14 513 TELTOW / Germany Tel: (+49) 3328 4784-0 / Fax: (+49) 3328 4784-30

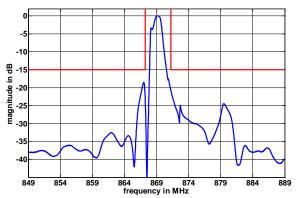
only. Should there be additional questions do not hesitate to ask for an application note or contact our design team.

^{**)} power durability requirement is 10 dBm for each 4 seconds per hour over lifetime ***) $\Delta f_C(Hz) = Tc_1(ppm/K^2) \times (T - T_0)^2 \times f_{CAT}(MHz)$

Microchip Filter specification TFS 869L 2/5

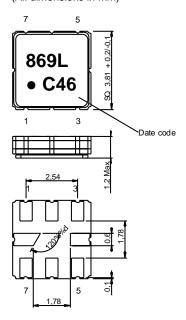
Filter characteristic





Construction and pin connection

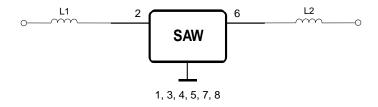
(All dimensions in mm)



1	Ground
2	Input
3	Ground
4	Ground
5	Ground
6	Output
7	Ground
8	Ground

Date code: Year + week B 2011 C 2012 D 2013 ...

50 Ohm Test circuit



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Stability characteristics, reliability

After the following tests the filter shall meet the whole specification:

1. Shock: 500g, 1 ms, half sine wave, 3 shocks each plane;

DIN IEC 68 T2 - 27

2. Vibration: 10 Hz to 500 Hz, 0,35 mm or 5 g respectively, 1 octave per min, 10 cycles per

plane, 3 planes; DIN IEC 68 T2 - 6

3. Change of

temperature: -55 °C to 125°C / 30 min. each / 10 cycles

DIN IEC 68 part 2 - 14 Test N

4. Resistance to

solder heat (reflow): reflow possible: three times max.;

for temperature conditions, see page 4: "Air reflow temperature conditions"

5. ESD ANSI/ESD S20.20-1999, class 1A for HBM

This filter is RoHS compliant (2002/95/EG, 2005/618/EG)

Packing

Tape & Reel: IEC 286 – 3, with exception of value for N and minimum bending radius;

tape type II, embossed carrier tape with top cover tape on the upper side;

max. pieces of filters per reel:

reel of empty components at start:

reel of empty components at start including leader:

min. 300 mm

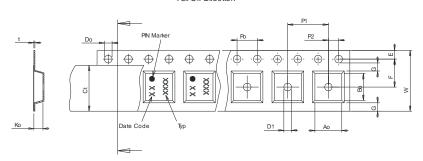
min. 500 mm

min. 300 mm

Pull Off Direction ─►

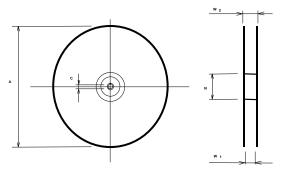
Tape (all dimensions in mm)

W $12,00 \pm 0,3$ $4,00 \pm 0,1$ 1,50 +0,1/-0Po Do $1,75 \pm 0,1$ Е F $5,50 \pm 0,05$ G(min) 0,75 2,00 ± 0,05 P2 P1 $8,00 \pm 0,1$ 1,50 D1(min) $4,30 \pm 0,1$ Αo Во $4,30 \pm 0,1$ 9,2 ± 0,1



Reel (all dimensions in mm)

A :330 W1 : 12,4 +2/-0 W2(max) : 18,4 N(min) : 50 C : 13,0 +0,5/-0,2



The minimum bending radius is 45 mm.

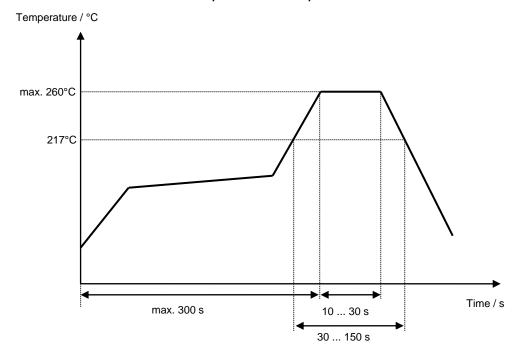
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Microchip Filter specification TFS 869L 4/5

Air reflow temperature conditions

Conditions	Exposure
Average ramp-up rate (30°C to 217°C)	less than 3°C/second
> 100°C	between 300 and 600 seconds
> 150°C	between 240 and 500 seconds
> 217°C	between 30 and 150 seconds
Peak temperature	max. 260°C
Time within 5°C of actual peak temperature	between 10 and 30 seconds
Cool-down rate (Peak to 50°C)	less than 6°C/second
Time from 30°C to Peak temperature	no greater than 300 seconds

Chip-mount air reflow profile



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Microc	hip	Filter specification	TFS 869	DL 5/5
History				
Version	Reason of Changes		Name	Date
1.0	- Generation of development specificat	ion	Noack	29.08.2011
2.0	 Change from development spec to fili Temperature coefficient updated Typical values added Filter characteristic added 	er spec	Molke	16.11.2012

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